

# **NCE N-Channel Super Trench II Power MOSFET**

### **Description**

The series of devices uses **Super Trench II** technology that is uniquely optimized to provide the most efficient high frequency switching performance. Both conduction and switching power losses are minimized due to an extremely low combination of  $R_{\text{DS(ON)}}$  and  $Q_g$ . This device is ideal for high-frequency switching and synchronous rectification.

### **Application**

- DC/DC Converter
- ●Ideal for high-frequency switching and synchronous rectification

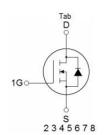
#### **General Features**

- $V_{DS}$  =85V, $I_D$  =210A  $R_{DS(ON)}$ =2.65m $\Omega$  , typical @  $V_{GS}$ =10V
- Excellent gate charge x R<sub>DS(on)</sub> product(FOM)
- Very low on-resistance R<sub>DS(on)</sub>
- 175 °C operating temperature
- Pb-free lead plating

100% UIS TESTED! 100% ΔVds TESTED!







**Schematic Diagram** 

# **Package Marking and Ordering Information**

Device Marking	Device	Device Package	Reel Size	Tape width	Quantity
NCEP030N85LL	NCEP030N85LL	TOLL	-	-	-

### Absolute Maximum Ratings (T<sub>C</sub>=25℃unless otherwise noted)

Parameter	Symbol	Limit	Unit
Drain-Source Voltage	V <sub>DS</sub>	85	V
Gate-Source Voltage	V <sub>G</sub> s	±20	V
Drain Current-Continuous	I <sub>D</sub>	210	А
Drain Current-Continuous(Tc=100℃)	I <sub>D</sub> (100℃)	160	Α
Pulsed Drain Current	I <sub>DM</sub>	840	А
Maximum Power Dissipation	P <sub>D</sub>	300	W
Derating factor		2.0	W/℃
Single pulse avalanche energy (Note 1)	Eas	1350	mJ
Operating Junction and Storage Temperature Range	$T_{J}, T_{STG}$	-55 To 175	$^{\circ}$

#### **Thermal Characteristic**

Thermal Resistance,Junction-to-Case	R <sub>θJC</sub>	0.5	°C/W
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# Electrical Characteristics (T<sub>C</sub>=25 ℃ unless otherwise noted)

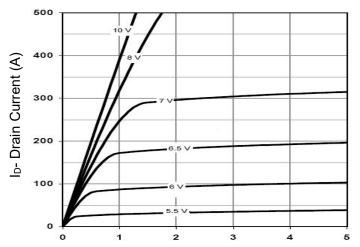
Parameter	Symbol	Condition	Min	Тур	Max	Unit
Off Characteristics	,					•
Drain-Source Breakdown Voltage	BV <sub>DSS</sub>	V <sub>GS</sub> =0V I <sub>D</sub> =250µA	85		-	V
Zero Gate Voltage Drain Current	Ipss	V <sub>DS</sub> =85V,V <sub>GS</sub> =0V	-	-	1	μA
Gate-Body Leakage Current	Igss	V <sub>GS</sub> =±20V,V <sub>DS</sub> =0V	-	-	±100	nA
On Characteristics						•
Gate Threshold Voltage	V <sub>GS(th)</sub>	$V_{DS}=V_{GS},I_{D}=250\mu A$	2.0	3.0	4.0	V
Drain-Source On-State Resistance	R <sub>DS(ON)</sub>	V <sub>GS</sub> =10V, I <sub>D</sub> =125A	-	2.65	3.0	mΩ
Forward Transconductance	<b>G</b> FS	V <sub>DS</sub> =5V,I <sub>D</sub> =125A		90	-	S
Dynamic Characteristics						•
Input Capacitance	C <sub>lss</sub>	\/ 40\/\/ 0\/	-	7200	-	PF
Output Capacitance	Coss	$V_{DS}$ =40V, $V_{GS}$ =0V,	-	1100	-	PF
Reverse Transfer Capacitance	C <sub>rss</sub>	F=1.0MHz	-	24	-	PF
Switching Characteristics (Note 2)			'			
Turn-on Delay Time	t <sub>d(on)</sub>		-	21	-	nS
Turn-on Rise Time	t <sub>r</sub>	$V_{DD}$ =40 $V$ , $I_{D}$ =125 $A$	-	12.5	-	nS
Turn-Off Delay Time	t <sub>d(off)</sub>	$V_{GS}$ =10V, $R_{G}$ =1.6 $\Omega$	-	48	-	nS
Turn-Off Fall Time	t <sub>f</sub>		-	12	-	nS
Total Gate Charge	Qg	V 40V/ 1 405A	-	115	-	nC
Gate-Source Charge	Q <sub>gs</sub>	$V_{DS}=40V, I_{D}=125A,$	-	39		nC
Gate-Drain Charge	Q <sub>gd</sub>	V <sub>GS</sub> =10V	-	32		nC
Drain-Source Diode Characteristics	,				'	
Diode Forward Voltage	V <sub>SD</sub>	V <sub>GS</sub> =0V,I <sub>S</sub> =125A	-		1.2	V
Diode Forward Current	Is		-	-	210	Α
Reverse Recovery Time	t <sub>rr</sub>	T <sub>J</sub> = 25°C, I <sub>F</sub> = 125A	-	80	-	nS
Reverse Recovery Charge	Qrr	di/dt = 100A/µs	-	147	-	nC

### Notes:

- 1. EAS condition : Tj=25  $^{\circ}\text{C}$  ,VDD=40V,VG=10V,L=0.5mH,Rg=25 $\Omega$
- 2. Guaranteed by design, not subject to production
- 3. These curves are based on the junction-to-case thermal impedance which is measured with the device mounted to a large heatsin k, assuming a maximum junction temperature of TJ(MAX)=175° C. The SOA curve provides a single pulse rating.

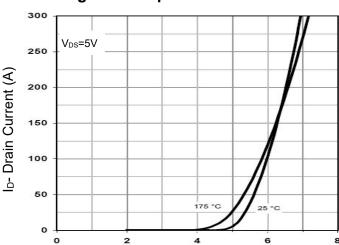


# **Typical Electrical and Thermal Characteristics**



Vds Drain-Source Voltage (V)





Vgs Gate-Source Voltage (V)

# **Figure 2 Transfer Characteristics**

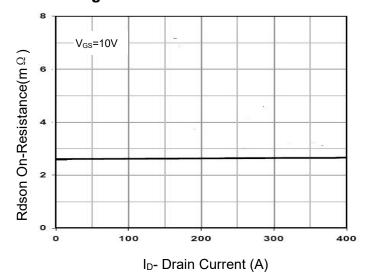
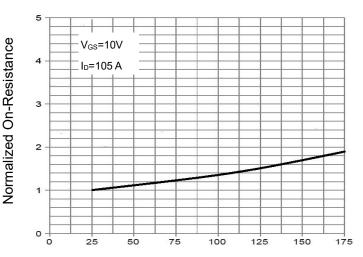
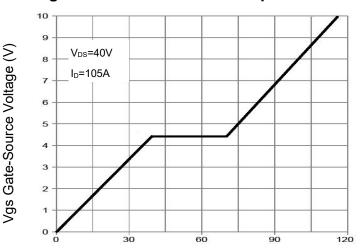


Figure 3 Rdson- Drain Current

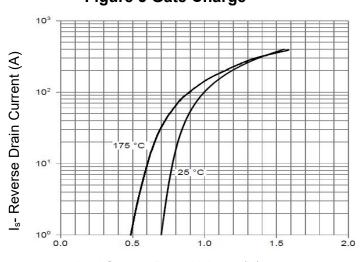


T<sub>J</sub>-Junction Temperature(°C)

# Figure 4 Rdson-Junction Temperature



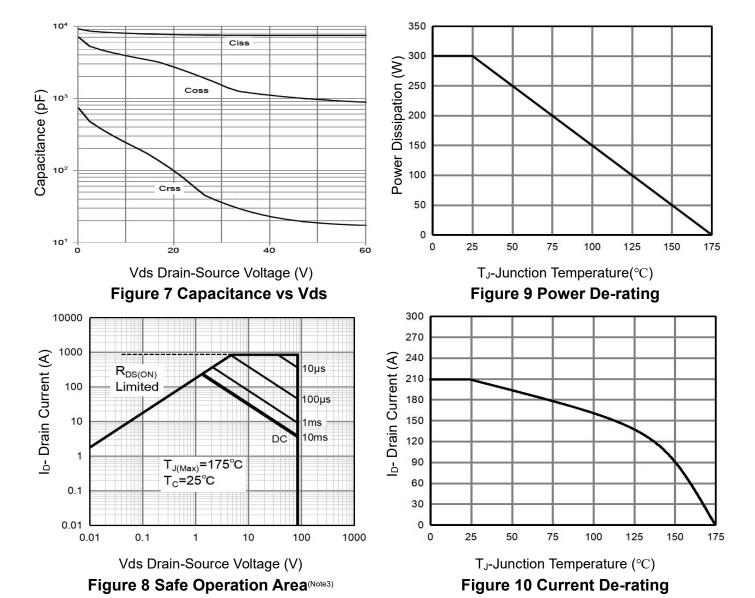
Qg Gate Charge (nC)
Figure 5 Gate Charge



Vsd Source-Drain Voltage (V)

Figure 6 Source- Drain Diode Forward





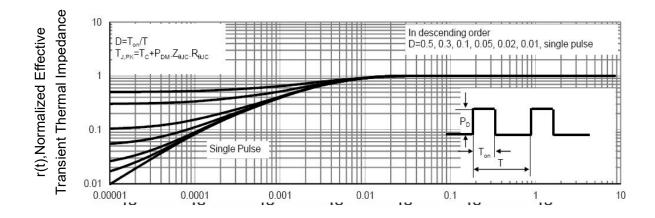


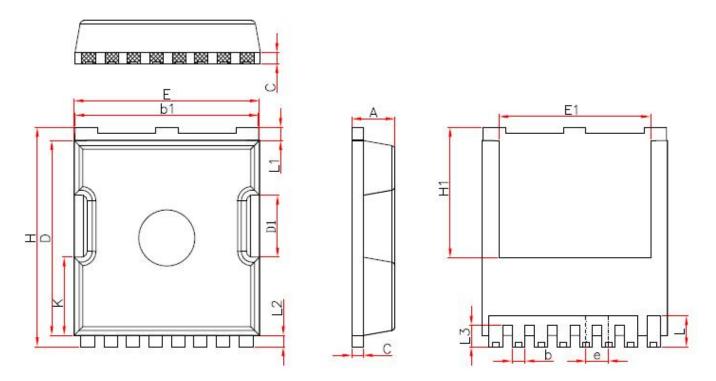
Figure 11 Normalized Maximum Transient Thermal Impedance

Square Wave Pluse Duration(sec)

V3.0



# **TOLL Package Information**



Symbol	Millimeters			
VERG	Min.	Nom.	Max.	
A	2.20	2.30	2.40	
b	0.65	0.75	0.85	
b1	9.70	9.80	9.90	
С	0.50	0.60	0.70	
D	10.30	10.40	10.50	
D1	3.15	3.3	3.45	
Е	9.70	9.90	10.10	
E1	8.00	8.10	8.20	
е	1.10	1.20	1.30	
Н	11.6	11.7	11.8	
H1	6.85	6.95	7.05	
K	4.08	4.18	4.28	
L	1.60	1.65	2.10	
L1	0.60	0.70	0.80	
L2	0.50	0.60	0.70	
L3	1.05	1.20	1.30	



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